

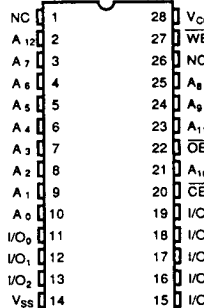
8K X 8 CMOS Electrically Erasable PROM 5ms Nonvolatile Write Cycle

FEATURES

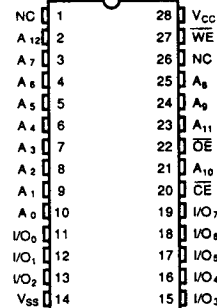
- **Fast Read Access Times**
— 120ns, 150ns, 200ns and 250ns
- **Low CMOS Power Consumption**
— 60mA (Active)
— 150µA (Standby)
- **5 Volt-only Operation**
— Including write
- **Fast Nonvolatile Write Cycle**
— Internally latched data and address
— 120ns byte-load cycle
— 5ms (max.) nonvolatile write cycle
- **Self-Timed Writes**
— Effective 75µs/byte write
— 64 byte page input buffer
— Auto-erase before write
— DATA Polling
- **Automatic Page Write Mode**
— 64 byte page size
— 5ms page write time
- **On-chip Inadvertent Write Protection**
- **10,000 Rewrites per Byte**
- **10 Year Secure Data Retention**
- **ESD Protected to 2000V**

PIN CONFIGURATIONS

28 Pin CERDIP
Type "C" Package

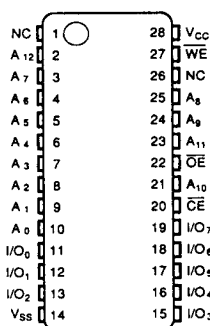


28 Pin Plastic DIP
Type "P" Package

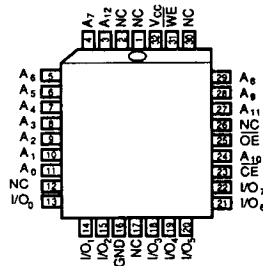


PARALLEL
3
PAGES

28 Pin SOIC
Type "J" Package



32 Pin PLCC
Type "D" Package



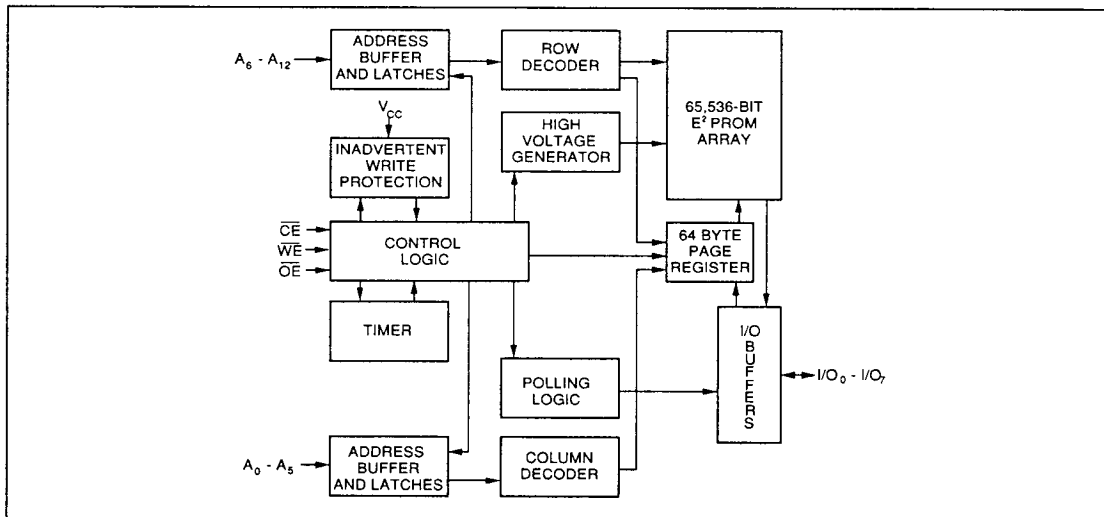
OVERVIEW

The XL28C64 is a full-featured, 8K x 8 bit CMOS E²PROM (Electrically Erasable Programmable Read Only Memory). Operationally, it is compatible with industry standard 64K devices, but offers improved speed and power efficiency. Read access times can be as low as 120ns; standby current, less than 100µA. It features a page-wide input buffer and improved protection against inadvertent writes. Operating modes function from a single 5V power supply, and the XL28C64 is manufactured with EXEL's proven double-metal, 1.4µ CMOS process.

PIN NAMES

A0-A12	Address Inputs
I/O0- I/O7	Data Inputs/Outputs
CE	Chip Enable
OE	Output Enable
WE	Write Enable
VCC	Supply Voltage
VSS	Power and Signal Ground
NC	No Connect

BLOCK DIAGRAM



The sophisticated architecture of this device provides complete and automatic control of the nonvolatile write cycle eliminating the need for external timers, latches, high voltage generators and supplemental inadvertent write protection circuitry. It fits into standard SRAM sockets and responds to typical SRAM write commands.

The fully-automatic 64-byte page-write allows the entire memory to be programmed in less than 0.65 sec. Internal latches, for address and data, free the system bus during the 5ms self-timed, nonvolatile write period. Moreover, the byte-load cycle time matches the read access time, adding to system performance.

Inadvertent writes are inhibited by a wide range of protections built into the XL28C64. A low V_{CC} lockout feature disables nonvolatile write cycles when V_{CC} drops below 3.5V (V_{WI}) (typical). Additionally, the XL28C64 features power-on reset and noise protected \overline{WE} .

The XL28C64 is compatible with existing 64K E²PROMs—both pinout and operating modes conform to industry standards. This compatibility extends to higher and lower density E²PROMs as well.

APPLICATIONS

The nonvolatile storage in the XL28C64 replaces dip switches as a means of storing configuration data. It delivers firmware for booting up systems, and for operating industrial and process controllers, traffic controllers, robotics and telemetry, measuring instruments and appliance controls. It retains phone numbers and messages in telephones and facsimile machines. The XL28C64 is ideal in applications that are self-adapting, such as video games and systems that require automatic re-calibration, as well as those that are subject to power failures.

ENDURANCE and DATA RETENTION

The XL28C64 is designed for applications requiring up to 10,000 data changes per E²PROM byte ensuring a guaranteed endurance of 20 million data changes per device. It provides 10 years of secure data retention, with or without power applied after the data is written.

DEVICE OPERATION

Three control pins (\overline{CE} , \overline{OE} and \overline{WE}) select all standard, user operating modes for the XL28C64. Chip erase (typically executed during test procedures) requires a higher supply voltage on one input pin. This conforms with existing E²PROM standards.

Read Mode

Data is read from the XL28C64 by bringing both \overline{CE} and \overline{OE} LOW while keeping \overline{WE} HIGH. With the read mode selected, address lines can be changed at any time, in any order to read data at various locations in the E²PROM array. Read access time is measured from the latter of either the time when the controlling line goes LOW (\overline{CE} or \overline{OE}), or the time when the address is established.

The device can be read an unlimited number of times, because the stored charge that defines the bit state is not affected by a read cycle.

Write Mode

The XL28C64 uses a two-step process to store new data. Byte-load cycles fill latches in a volatile page buffer. A subsequent nonvolatile write cycle transfers this data in the page-buffer to the E²PROM array without user intervention.

The XL28C64 contains (128) 64-byte pages. Address lines A₆-A₁₂ identify the page; lines A₀-A₅ identify the byte within the page. All bytes written within one nonvolatile write cycle must be on the same page. (A₆-A₁₂ must remain unchanged.) Any number of the 64 bytes in the page can be written or re-written, in any order; the last data written to any given byte when the nonvolatile write cycle begins is retained.

Either \overline{WE} or \overline{CE} can be used to initiate the byte-load cycle. The address is latched into internal address latches upon the last falling edge of \overline{WE} or \overline{CE} . An internal byte-load timer is started on the falling edge of the

controlling line. The timer provides a 100 μ s window for initiating the next byte-load cycle. Byte-loading can continue indefinitely if each new load cycle is started within the timeout period.

When the byte-load timer times out, additional external byte-load cycles are ignored and data is automatically transferred from the page buffer to the E²PROM array through an internally managed nonvolatile write cycle. Byte flags, set during the byte-load cycles, ensure that high voltage is applied only to newly written bytes. By avoiding the unnecessary cycling of bytes, the endurance of the array is extended. The high voltage cycle is immune to any overlapping control pin activity.

An internal write-flag is set on the first byte-load of each write cycle. Data pins remain in a high impedance state except during a byte-load (when they contain the forced input data) or during a \overline{DATA} polling read (see below). When the high voltage cycle is completed, the write-flag is reset and the operating mode is again determined by the control pins (\overline{CE} , \overline{OE} and \overline{WE}).



Standby Mode

Whenever \overline{CE} is brought HIGH, the device operates in standby mode, with the I/O pins in a high impedance state. Standby power dissipation is less than 100 μ A with CMOS level inputs.

Chip Erase — High Voltage Mode

The chip erase mode allows the user to erase the entire E²PROM array with a single command. The method requires the application of high voltage (V_H) on the \overline{OE} pin, with \overline{CE} at a logical "0." Chip erase is initiated by a standard byte write command, but in this case, the data on the I/O pins is ignored. A byte containing all "1's" is automatically written to all locations in the E²PROM array. (Refer to the Mode Selection chart.)

MODE SELECTION

\overline{CE}	\overline{OE}	\overline{WE}	Mode	I/O	Power
V _{IH}	X	X	Standby	HIGH Z	Standby
V _{IL}	V _{IL}	V _{IH}	Read	D _{OUT}	Active
V _{IL}	V _{IH}		Byte Write (\overline{WE} Controlled)	D _{IN}	Active
	V _{IH}	V _{IL}	Byte Write (\overline{CE} Controlled)	D _{IN}	Active
V _{IL}	V _H	V _{IL}	Chip Erase*	Data In = X	Active
V _{IL}	V _{IL}	V _{IH}	\overline{DATA} Polling	$\overline{D_7}$	Active
X	V _{IL}	X	Write Inhibit	X	Active

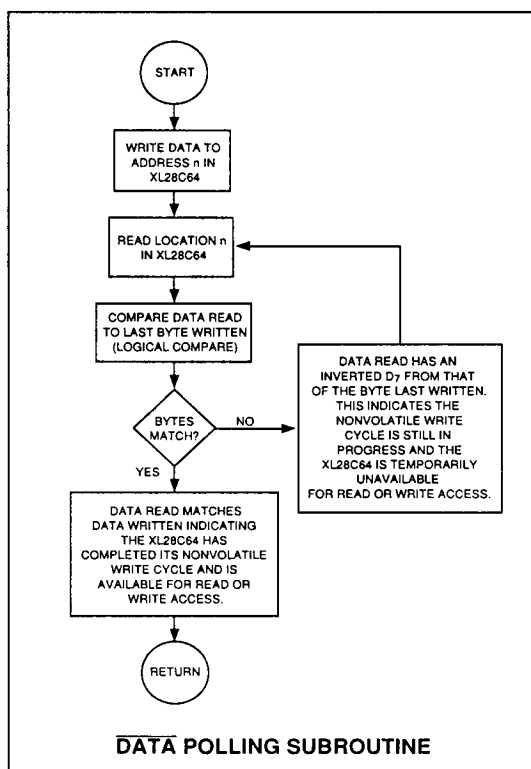
*Contact EXEL for details.



DATA Polling

The XL28C64 provides a feature named DATA polling which enables the host system to determine the status of the device through the use of the system busses. No additional hardware is required. Any attempt to read the part while the XL28C64 is busy executing its nonvolatile write cycle will be interpreted as a DATA polling read. This is performed by exercising the control pins in the same sequence as for a normal read. DATA polling cycles have no effect on the byte-load timer, contents of the data buffer or the nonvolatile cycle timing.

DATA polling is a simple software technique used to determine the status of the XL28C64. It is executed as a normal read cycle where the target byte location is the same as that of the byte last written to the XL28C64. During the 5ms (max.) period that the device requires to complete its nonvolatile write cycle, the I/O buffers are set in a high impedance state with the exception of I/O7. I/O7 is set to output the complement of the value of the MSB of the last byte written to the XL28C64 **when a read command is asserted**.



The READY/BUSY test procedure is quite simple. The system simply reads the location last written to in the XL28C64 and executes a compare operation between the data thus retrieved and the original data byte written. If the compare fails, the XL28C64 is still busy with its nonvolatile write cycle. If the compare passes, the nonvolatile write cycle is complete and the device is available for read or write accesses.

This procedure is commonly used to determine the actual nonvolatile write cycle completion timing, eliminating the need to await the 5ms (max.) period specified, and enabling accelerated device loading operations.

WRITE PROTECT MECHANISMS

The XL28C64 features several integrated mechanisms to protect it from inadvertent writes that might occur during system power supply transitions or periods of system noise.

OE Write Inhibit

If OE is brought LOW before the CE and WE write command sequence, the internal nonvolatile write cycle will not occur. See the Mode Selection Table on page 3. In addition to the user-controlled protection mechanisms, the following specialized circuits are built in.

Vcc Lockout

The XL28C64 has a specialized power supply monitor circuit integrated to protect the device from inadvertent write commands asserted by the system during low Vcc conditions. This circuitry constantly evaluates the power supply voltage level applied to the XL28C64 and actively inhibits the initiation of nonvolatile write cycles if the applied supply voltage falls below V_{WI}. This circuitry does not abort nor affect nonvolatile write cycles already in progress, yet inhibits new cycles from being initiated.

Power-Up Write Enable Delay

At power-up, operation is inhibited until Vcc is stable and sufficiently high. Write operations are inhibited until 1ms after Vcc reaches 2.0V to allow the system to stabilize while blocking potential inadvertent write commands.

Noise Protection

Write pulses of less than 10ns duration on the WE pin will not initiate nonvolatile write cycles.

ABSOLUTE MAXIMUM RATINGS

Temperature Under Bias	-55°C to +125°C
Storage Temperature	-65°C to +150°C
Lead Soldering Temperature (less than 10 seconds)	300°C
Supply Voltage	0 to 6.5V
Voltage on Any Pin*	-1.0 to +7.0V
Voltage on OE Pin*	-1.0 to +15V
ESD Rating	2000V
DC Output Current	5mA
*With respect to ground	

NOTE: These are STRESS ratings only. Appropriate conditions for operating these devices are given elsewhere in this specification. Stresses beyond those listed here may permanently damage the part. Prolonged exposure to maximum ratings may affect device reliability. Although this product includes specific circuitry to protect it from electrostatic discharge, conventional precautions should be taken to avoid any voltages higher than the rated maxima.



DC ELECTRICAL CHARACTERISTICS

TA = 0°C to +70°C for the XLS28C64 or -40°C to +85°C for the XLE28C64, VCC = 5V ±10%

Symbol	Parameter	Test Conditions	Min.	Max.	Units
I _{CC}	V _{CC} Current — Active (TTL)	CE = OE = V _{IL} WE = V _{IH} I/O's = open A0-A12 toggling @ 5MHz		60	mA
I _{SB}	V _{CC} Current — Standby (TTL)	CE = WE = V _{IH} OE = V _{IL} I/O's = open A0-A12 = V _{CC}		2	mA
I _{SB} C	V _{CC} Current — Standby (CMOS)	CE = WE = V _{CC} - 2V OE = V _{SS} + 0.2V I/O's = open A0-A12 = V _{CC}		150	μA
I _{LI}	Input Leakage Current	V _{IN} = GND to V _{CC}		10	μA
I _{LO}	Output Leakage — Standby	V _{OUT} = GND to V _{CC} CE = V _{IH}		10	μA
V _{IL}	Input Low Voltage		-0.5	0.8	V
V _{IH}	Input High Voltage		2.0	V _{CC} + 0.5	V
V _{OL1}	Output Low Voltage	I _{OL} = 2.1mA		0.4	V
V _{OH1}	Output High Voltage	I _{OH} = -400μA I _{OH} = -10μA	2.4 V _{CC} -0.1		V
V _H	High Voltage for Chip Erase		11.4	12.6	V

CAPACITANCE

TA = 25°C, f = 1.0MHz

Symbol	Test	Test Conditions	Max.	Units
C _{I/O}	Input/Output Capacitance	V _{I/O} = 0V	10	pF
C _{IN}	Input Capacitance	V _{IN} = 0V	6	pF

AC OPERATING CHARACTERISTICS

READ CYCLE (See Figures 1 and 2)

TA=0°C to +70°C for the XLS28C64 or -40°C to +85°C for the XLE28C64, VCC=5V±5%

Symbol	Test	XL28C64-120		XL28C64-150		XL28C64-200		XL28C64-250		Units
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
tRC	Read Cycle Time	120		150		200		250		ns
tAA	Address Access Time		120		150		200		250	ns
tCE	Chip Enable Access Time		120		150		200		250	ns
tOE	Output Enable Access Time		50		60		75		100	ns
tLZ	Chip Enable to Output in Low Z	0		0		0		0		ns
tHZ	Chip Disable to Output in High Z	0	50	0	50	0	50	0	50	ns
tOLZ	Output Enable to Output in Low Z	0		0		0		0		ns
tOHZ	Output Disable to Output in High Z	0	50	0	50	0	50	0	50	ns
tOH	Output Hold from Address Change	15		15		15		15		ns

WRITE CYCLE (See Figures 3, 4 and 5)

TA=0°C to +70°C for the XLS28C64 or -40°C to +85°C for the XLE28C64, VCC=5V±5%

Symbol	Test	Min.	Max.	Units
tWC	Write Cycle Time		5	ms
tBLC	Byte Load Cycle	.120	100	μs
tAS	Address Setup Time	0		ns
tAH	Address Hold Time	35		ns
tCS	Write Setup Time	0		ns
tCH	Write Hold Time	0		ns
tCW	Chip Enable Pulse Width	50		ns
tOES	Output Enable Setup Time	5		ns
tOEH	Output Enable Hold Time	5		ns
tWP	Write Enable Pulse Width	70		ns
tWPH	Write Pulse Width High	50		ns
tDS	Data Setup Time	30		ns
tDH	Data Hold Time	0		ns
tDV	Data Valid Time		1	μs
tINIT	Power-up Initialization Period		20	ms

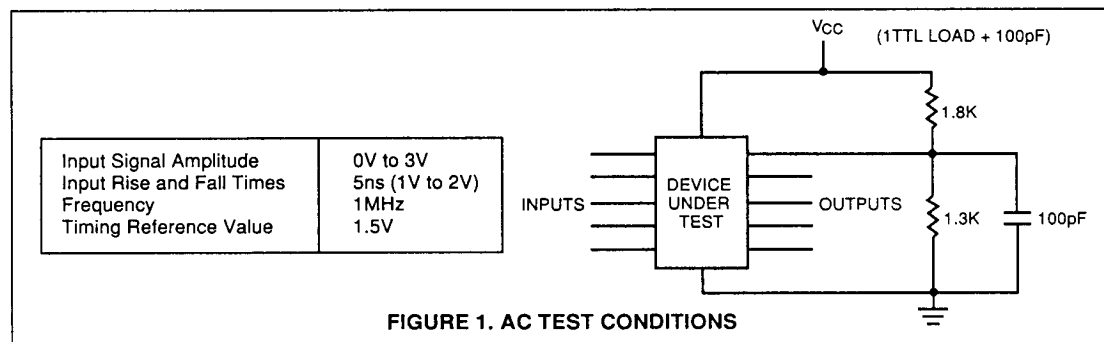


FIGURE 1. AC TEST CONDITIONS

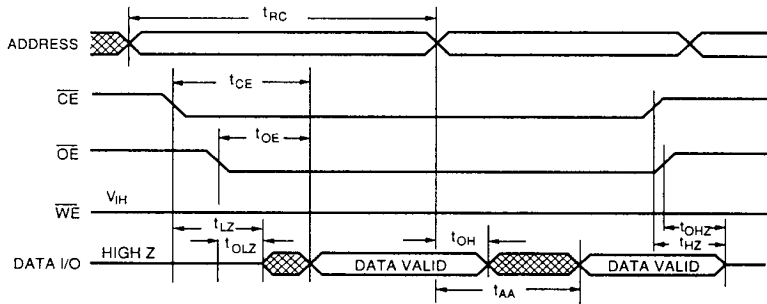


FIGURE 2. READ CYCLE TIMING

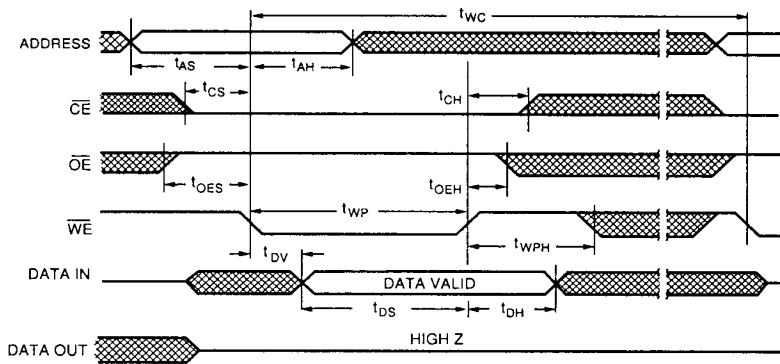


FIGURE 3. \overline{WE} CONTROLLED WRITE CYCLE TIMING

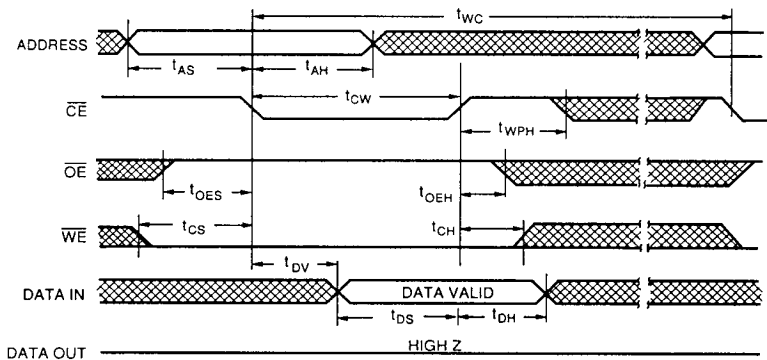


FIGURE 4. \overline{CE} CONTROLLED WRITE CYCLE TIMING

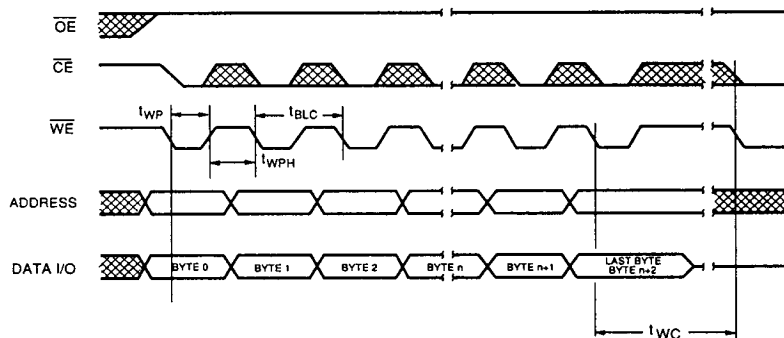


FIGURE 5. PAGE MODE WRITE CYCLE TIMING

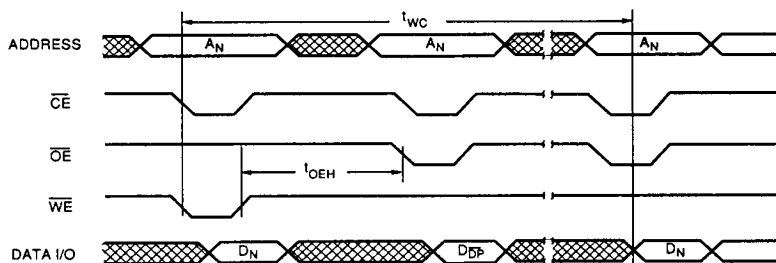


FIGURE 6. DATA POLLING TIMING